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Kind regards,

Team Nexperia



ESD protection for high-speed interfaces Rev. 2 — 13 December 2012

Product data sheet

1. Product profile

1.1 General description

The device is designed to protect high-speed interfaces such as USB 2.0, Ethernet and Digital Visual Interface (DVI) against ElectroStatic Discharge (ESD).

The device includes four high-level ESD protection diode structures for high-speed signal lines and is encapsulated in a leadless ultra small DFN1410-6 (SOT886) plastic package.

Special diode configuration protects all signal lines and offers ultra low line capacitance of only 1 pF. The rail-to-rail diodes are connected to the Zener diode which allows ESD protection to be independent of supply voltage.

1.2 Features and benefits

- System ESD protection for high-speed data lines such as USB 2.0, Ethernet and DVI
- All signal lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- Line capacitance of only 1 pF for each channel
- Leadless ultra small DFN1410-6 package: 1 × 1.45 × 0.5 mm; pitch 0.5 mm

1.3 Applications

The device is designed for high-speed receiver and transmitter port protection:

- Mobile phones, smartphones and handsets
- TVs and monitors
- DVD recorders and players
- Notebooks, mother boards, graphic cards and ports
- Set-top boxes and game consoles



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ESD protection for high-speed interfaces

2. Pinning information

Table	e 1. Pinning	I		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I/O 1	ESD protection		
2	GND	ground		6 5 4
3	I/O 2	ESD protection		
4	I/O 3	ESD protection		
5	V _{CC}	supply voltage		
6	I/O 4	ESD protection	Transparent top view	

3. Ordering information

Table 2. Ordering information						
Type number	Package	Package				
	Name	Description	Version			
IP4221CZ6-S	DFN1410-6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm	SOT886			

4. Marking

Table 3. Mark	ng codes
Type number	Marking code
IP4221CZ6-S	1S

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
VI	input voltage		-0.5	+5.5	V
V _{ESD}	electrostatic discharge voltage	IEC 61000-4-2, level 4; contact discharge	<u>[1]</u> –8	+8	kV
T _{stg}	storage temperature		-55	+125	°C
T _{amb}	ambient temperature		-40	+85	°C

[1] All pins to ground.

ESD protection for high-speed interfaces

6. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C _(I/O-GND)	input/output to ground capacitance	V _I = 0 V; f = 1 MHz; V _{CC} = 3 V	<u>[1][2]</u>	-	1	1.2	pF
I _{RM}	reverse leakage current	V _I = 3 V	[3][2]	-	-	100	nA
V _{BRzd}	Zener diode breakdown voltage	l _l = 1 mA	<u>[4]</u>	6	-	9	V
V _F	forward voltage	I _{test} = 10 mA		-	0.7	-	V

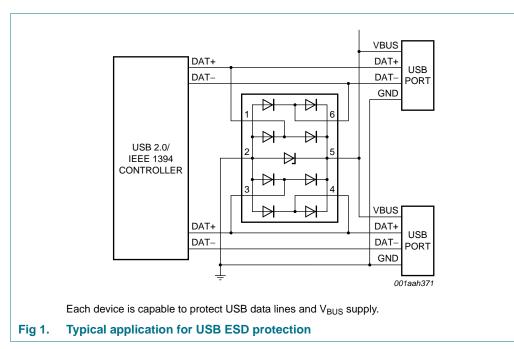
[2] Pins 1, 3, 4 and 6 are measured to ground.

[3] All pins measured to ground (pin 2).

[4] Measured from pin 5 to pin 2.

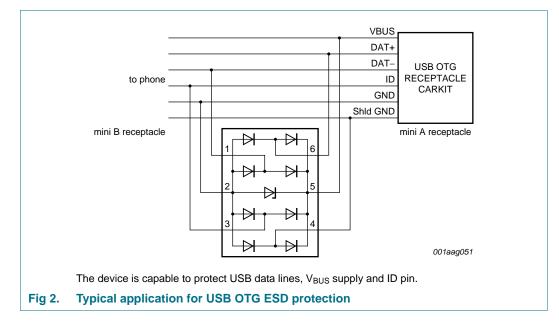
7. Application information

7.1 USB 1.1 and 2.0 protection



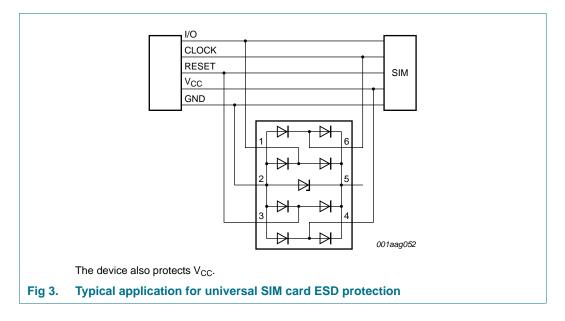
P4221CZ6-S Product data sheet

ESD protection for high-speed interfaces

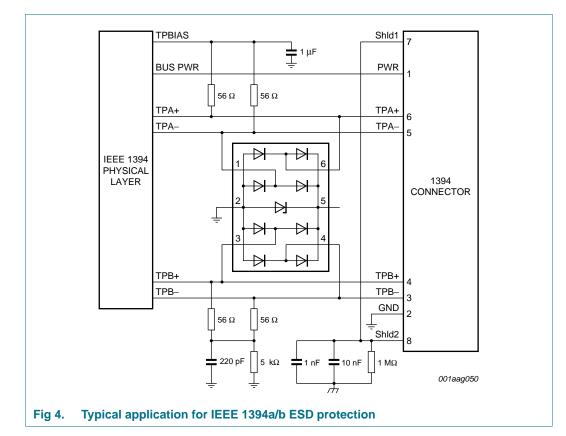


7.2 USB On-The-GO (OTG) protection

7.3 Universal SIM card protection



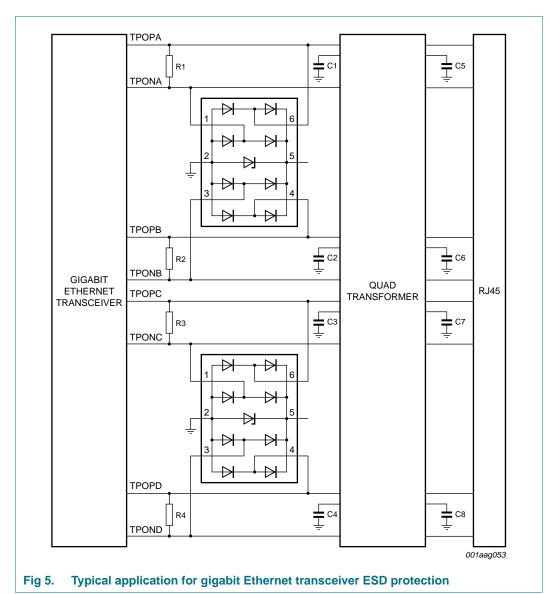
ESD protection for high-speed interfaces



7.4 IEEE 1394a/b protection

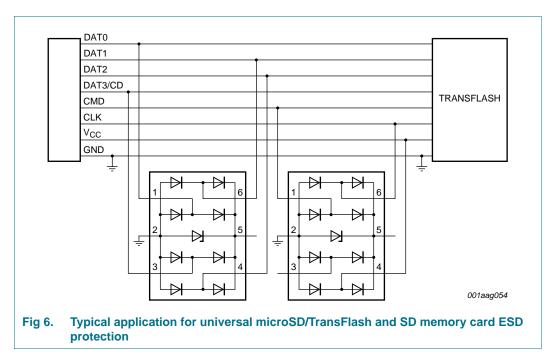
IP4221CZ6-S Product data sheet

ESD protection for high-speed interfaces



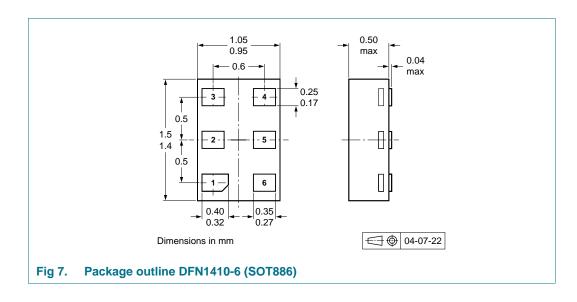
7.5 Gigabit Ethernet transceiver protection

ESD protection for high-speed interfaces



7.6 Universal microSD/TransFlash and SD memory card protection

8. Package outline



ESD protection for high-speed interfaces

9. Packing information

Table 6. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code. [1]

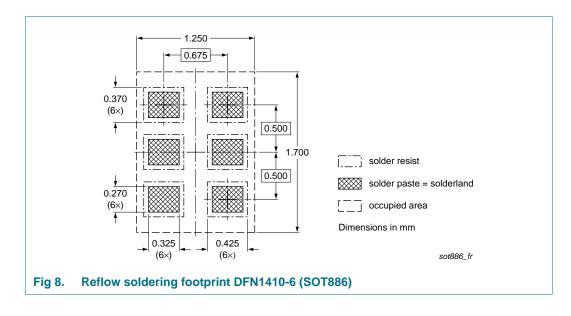
Type number	Package	Description		Packing quantity
				5000
IP4221CZ6-S	DFN1410-6 (SOT886)	4 mm pitch, 8 mm tape and reel; T1	[2]	-115
		4 mm pitch, 8 mm tape and reel; T4	[3]	-132

[1] For further information and the availability of packing methods, see <u>Section 13</u>.

[2] T1: normal taping

[3] T4: reverse taping

10. Soldering



P4221CZ6-S Product data sheet

ESD protection for high-speed interfaces

11. Revision history

Table 7. Revision his	story				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
IP4221CZ6-S v.2	20121213	Product data sheet	-	IP4221CZ6-S v.1	
Modifications:	 <u>Section 1 "Product profile</u>": updated <u>Section 4 "Marking</u>": added <u>Section 5 "Limiting values</u>": T_{amb} added Recommended operating conditions: removed 				
	 <u>Table 5 "Characteristics</u>": updated <u>Section 7 "Application information</u>": updated <u>Section 8 "Package outline</u>": drawing replaced with minimized package outline drawing <u>Section 10 "Soldering</u>": updated <u>Section 12 "Legal information</u>": updated 				
IP4221CZ6-S v.1	20080429	Product data sheet	-	-	

ESD protection for high-speed interfaces

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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Product data sheet

ESD protection for high-speed interfaces

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P4221CZ6-S Product data sheet

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